

Features

- Best acceleration sensitivity of 0.1 ppb/g
- Any frequencies between 1 MHz and 110 MHz accurate to 6 decimal places
- Extended temperature range (-55°C to 125°C)
- Excellent total frequency stability as low as ± 20 ppm
- Supply voltage of 1.8V or 2.25V to 3.63V
- Low power consumption of 3.8 mA typical at 1.8V
- Standby mode for longer battery life
- LVCMOS/LVTTL compatible output
- AEC-Q100 qualified
- Industry-standard packages: 2.0 x 1.6, 2.5 x 2.0, 3.2 x 2.5, 5.0 x 3.2, 7.0 x 5.0 mm x mm
- RoHS and REACH compliant, Pb-free, Halogen-free and Antimony-free
- [Contact SiTime](#) for up-screening and LAT programs

Applications

- Avionics systems
- Field communication systems
- Telemetry applications

Electrical Characteristics

Table 1. Electrical Characteristics^[1,2]

All Min and Max limits are specified over temperature and rated operating voltage with 15 pF output load unless otherwise stated. Typical values are at 25°C and nominal supply voltage.

Parameters	Symbol	Min.	Typ.	Max.	Unit	Condition
Frequency Range						
Output Frequency Range	f	1	–	110	MHz	Refer to Tables 13 to 15 for a list supported frequencies
Frequency Stability and Aging						
Frequency Stability	F_stab	-20	–	+20	ppm	Inclusive of Initial tolerance at 25°C, 1st year aging at 25°C, and variations over operating temperature, rated power supply voltage and load (15 pF \pm 10%)
		-25	–	+25	ppm	
		-30	–	+30	ppm	
		-50	–	+50	ppm	
Operating Temperature Range						
Operating Temperature Range (ambient)	T_use	-40	–	+85	°C	AEC-Q100 Grade 3
		-40	–	+105	°C	AEC-Q100 Grade 2
		-40	–	+125	°C	AEC-Q100 Grade 1
		-55	–	+125	°C	Extended cold AEC-Q100 Grade1
Rugged Characteristics						
Acceleration (g) sensitivity, Gamma Vector	F_g	–	–	0.1	ppb/g	Low sensitivity grade; total gamma over 3 axes; 15 Hz to 2 kHz; MIL-PRF-55310, computed per section 4.8.18.3.1
Supply Voltage and Current Consumption						
Supply Voltage	Vdd	1.62	1.8	1.98	V	All voltages between 2.25V and 3.63V including 2.5V, 2.8V, 3.0V and 3.3V are supported
		2.25	–	3.63	V	
Current Consumption	Idd	–	4.0	4.8	mA	No load condition, f = 20 MHz, Vdd = 2.25V to 3.63V
		–	3.8	4.5	mA	No load condition, f = 20 MHz, Vdd = 1.8V
OE Disable Current	I_od	–	–	4.5	mA	Vdd = 2.5V to 3.3V, OE = Low, Output in high Z state
		–	–	4.3	mA	Vdd = 1.8V, OE = Low, Output in high Zstate
Standby Current	I_std	–	2.6	–	μ A	Vdd = 2.8V to 3.3V, \overline{ST} = Low, Output is weakly pulled down
		–	1.4	–	μ A	Vdd = 2.5V, \overline{ST} = Low, Output is weakly pulled down
		–	0.6	–	μ A	Vdd = 1.8V, \overline{ST} = Low, Output is weakly pulled down

Table 1. Electrical Characteristics^[1,2] (continued)

Parameters	Symbol	Min.	Typ.	Max.	Unit	Condition
LVC MOS Output Characteristics						
Duty Cycle	DC	45	–	55	%	All Vdd levels
Rise/Fall Time	Tr, Tf	–	1.5	3	ns	Vdd = 2.25V - 3.63V, 20% - 80%
		–	1.3	2.5	ns	Vdd = 1.8V, 20% - 80%
Output High Voltage	VOH	90%	–	–	Vdd	IOH = -4 mA (Vdd = 3.0V or 3.3V) IOH = -3 mA (Vdd = 2.8V and Vdd = 2.5V) IOH = -2 mA (Vdd = 1.8V)
Output Low Voltage	VOL	–	–	10%	Vdd	IOL = 4 mA (Vdd = 3.0V or 3.3V) IOL = 3 mA (Vdd = 2.8V and Vdd = 2.5V) IOL = 2 mA (Vdd = 1.8V)
Input Characteristics						
Input High Voltage	VIH	70%	–	–	Vdd	Pin 1, OE or \overline{ST}
Input Low Voltage	VIL	–	–	30%	Vdd	Pin 1, OE or \overline{ST}
Input Pull-up Impedance	Z _{in}	–	100	–	kΩ	Pin 1, OE logic high or logic low, or \overline{ST} logic high
		2	–	–	MΩ	Pin 1, \overline{ST} logic low
Startup and Resume Timing						
Startup Time	T _{start}	–	–	5.5	ms	Measured from the time Vdd reaches its rated minimum value
Enable/Disable Time	T _{oe}	–	–	130	ns	f = 110 MHz. For other frequencies, T _{oe} = 100 ns + 3 * cycles
Resume Time	T _{resume}	–	–	5	ms	Measured from the time \overline{ST} pin crosses 50% threshold
Jitter						
RMS Period Jitter	T _{jitt}	–	1.6	2.5	ps	f = 75 MHz, 2.25V to 3.63V
		–	1.9	3.0	ps	f = 75 MHz, 1.8V
RMS Phase Jitter (random)	T _{phj}	–	0.5	–	ps	f = 75 MHz, Integration bandwidth = 900 kHz to 7.5 MHz
		–	1.3	–	ps	f = 75 MHz, Integration bandwidth = 12 kHz to 20 MHz

Notes:

- All electrical specifications in the above table are specified with 15 pF output load and for all Vdd(s) unless otherwise stated.
- The typical value of any parameter in the Electrical Characteristic table is specified for the nominal value of the highest voltage option for that parameter and at 25°C temperature.

Table 2. Pin Description

Pin	Symbol	Functionality
1	OE/ \overline{ST} /NC	Output Enable H ^[3] : specified frequency output L: output is high impedance. Only output driver is disabled.
		Standby H ^[3] : specified frequency output L: output is low (weak pull down). Device goes to sleep mode. Supply current reduces to I _{std} .
		No Connect Any voltage between 0 and Vdd or Open ^[3] : Specified frequency output. Pin 1 has no function.
2	GND	Power Electrical ground ^[4]
3	OUT	Output Oscillator output
4	VDD	Power Power supply voltage ^[4]

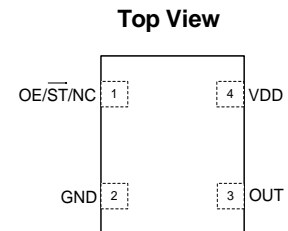


Figure 1. Pin Assignments

Notes:

- In OE or \overline{ST} mode, a pull-up resistor of 10 kΩ or less is recommended if pin 1 is not externally driven. If pin 1 needs to be left floating, use the NC option.
- A capacitor of value 0.1 μF or higher between Vdd and GND is required.

Table 3. Absolute Maximum Limits

Attempted operation outside the absolute maximum ratings may cause permanent damage to the part. Actual performance of the IC is only guaranteed within the operational specifications, not at absolute maximum ratings.

Parameter	Min.	Max.	Unit
Storage Temperature	-65	150	°C
Vdd	-0.5	4	V
Electrostatic Discharge	–	2000	V
Soldering Temperature (follow standard Pb free soldering guidelines)	–	260	°C
Junction Temperature ^[5]	–	150	°C

Note:

5. Exceeding this temperature for extended period of time may damage the device.

Table 4. Thermal Consideration^[6]

Package	θ_{JA} , 4 Layer Board (°C/W)	θ_{JA} , 2 Layer Board (°C/W)	θ_{JC} , Bottom (°C/W)
7050	142	273	30
5032	97	199	24
3225	109	212	27
2520	117	222	26
2016	152	252	36

Note:

6. Refer to JE51 for θ_{JA} and θ_{JC} definitions, and reference layout used to determine the θ_{JA} and θ_{JC} values in the above table.

Table 5. Maximum Operating Junction Temperature^[7]

Max Operating Temperature (ambient)	Maximum Operating Junction Temperature
85°C	95°C
105°C	115°C
125°C	135°C

Note:

7. Datasheet specifications are not guaranteed if junction temperature exceeds the maximum operating junction temperature.

Table 6. Environmental Compliance

Parameter	Condition/Test Method
Mechanical Shock	MIL-STD-883F, Method 2002
Mechanical Vibration	MIL-STD-883F, Method 2007
Temperature Cycle	JESD22, Method A104
Solderability	MIL-STD-883F, Method 2003
Moisture Sensitivity Level	MSL1 @ 260°C

Test Circuit and Waveform

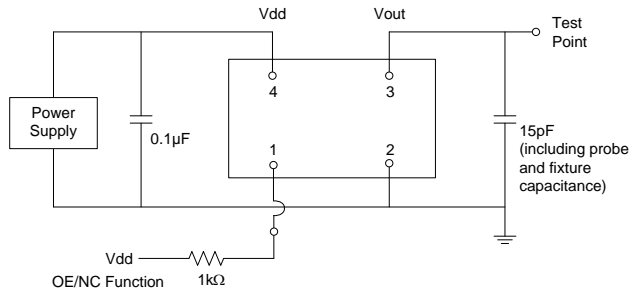


Figure 2. Test Circuit^[8]

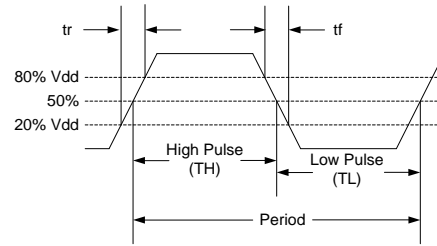
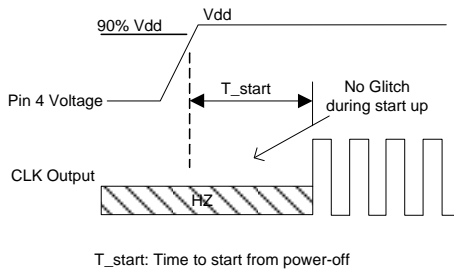


Figure 3. Waveform^[8]

Note:

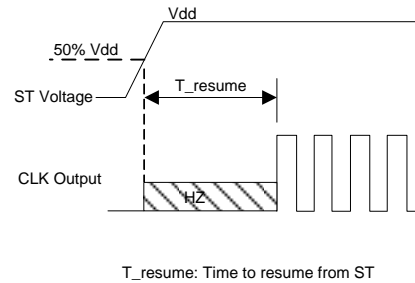
8. Duty Cycle is computed as $Duty\ Cycle = TH/Period$.

Timing Diagrams



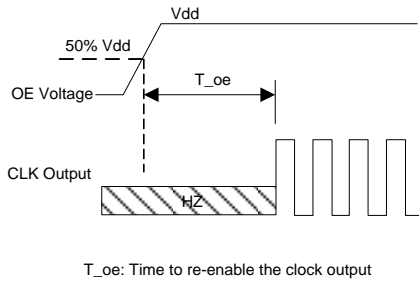
T_start: Time to start from power-off

Figure 4. Startup Timing (OE/ \overline{ST} Mode)^[9]



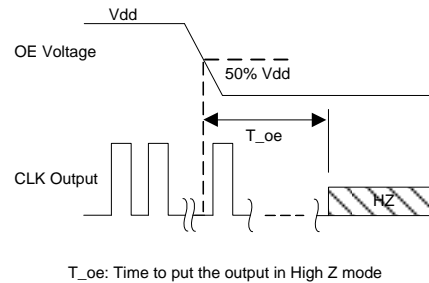
T_resume: Time to resume from ST

Figure 5. Standby Resume Timing (\overline{ST} Mode Only)



T_oe: Time to re-enable the clock output

Figure 6. OE Enable Timing (OE Mode Only)



T_oe: Time to put the output in High Z mode

Figure 7. OE Disable Timing (OE Mode Only)

Note:

9. SiT8944 has “no runt” pulses and “no glitch” output during startup or resume.

Performance Plots^[10]

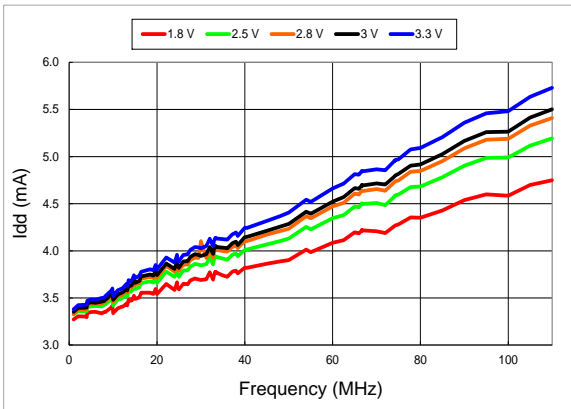


Figure 8. Idd vs Frequency

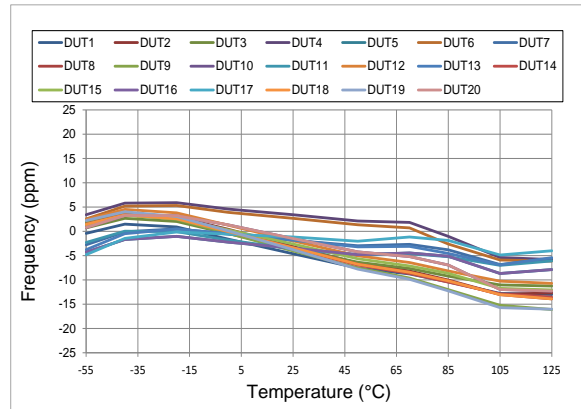


Figure 9. Frequency vs Temperature

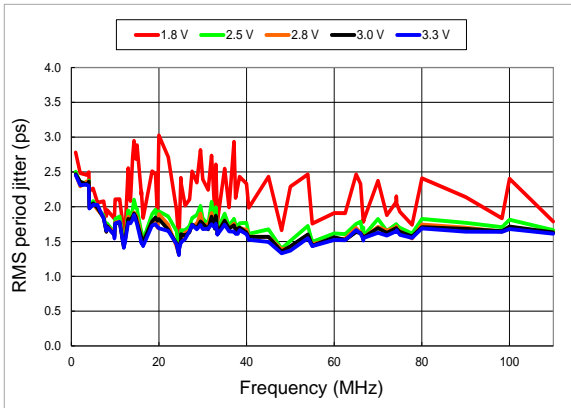


Figure 10. RMS Period Jitter vs Frequency

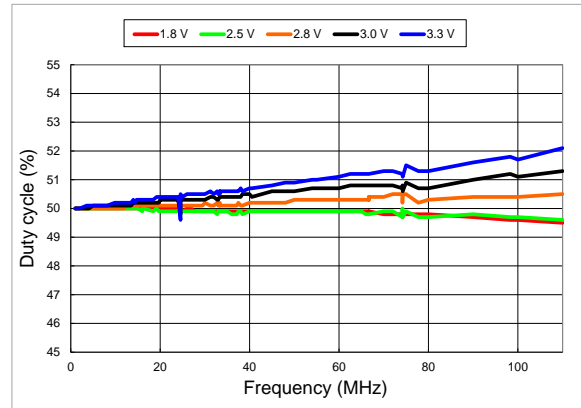


Figure 11. Duty Cycle vs Frequency

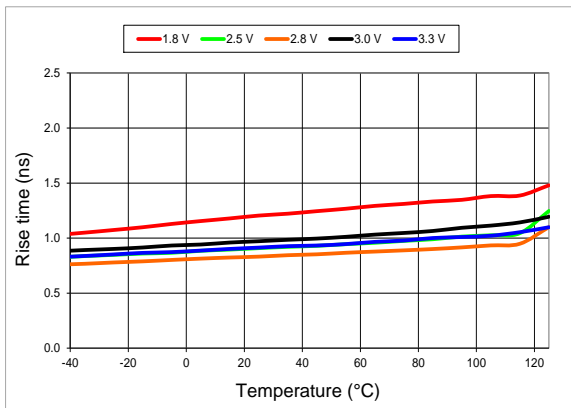


Figure 12. 20%-80% Rise Time vs Temperature

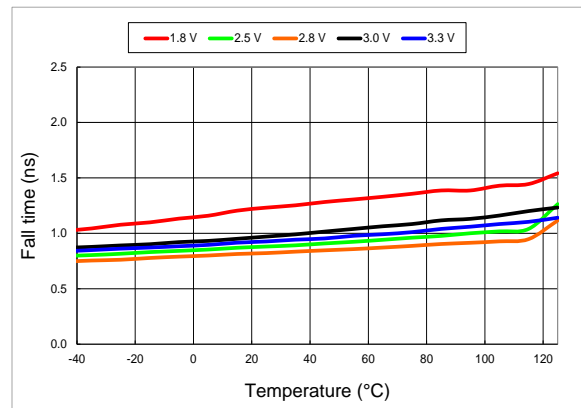


Figure 13. 20%-80% Fall Time vs Temperature

Performance Plots^[10]

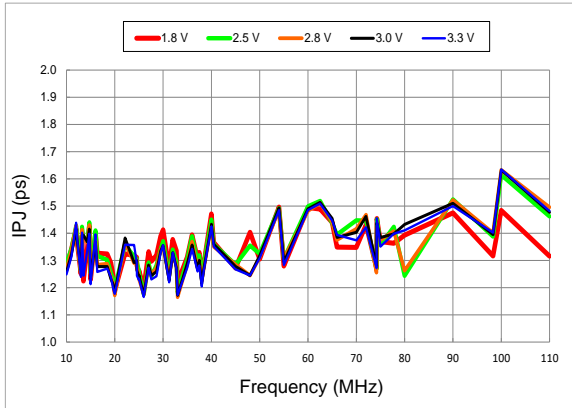


Figure 14. RMS Integrated Phase Jitter Random (12 kHz to 20 MHz) vs Frequency^[11]

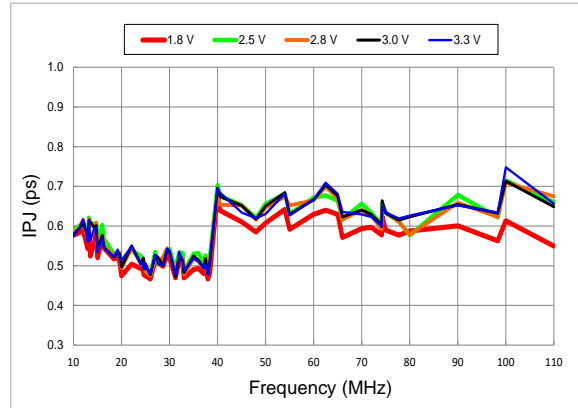


Figure 15. RMS Integrated Phase Jitter Random (900 kHz to 20 MHz) vs Frequency^[11]

Notes:

- 10. All plots are measured with 15 pF load at room temperature, unless otherwise stated.
- 11. Phase noise plots are measured with Agilent E5052B signal source analyzer. Integration range is up to 5 MHz for carrier frequencies up to 40 MHz.

Programmable Drive Strength

The SiT8944 includes a programmable drive strength feature to provide a simple, flexible tool to optimize the clock rise/fall time for specific applications. Benefits from the programmable drive strength feature are:

- Improves system radiated electromagnetic interference (EMI) by slowing down the clock rise/fall time.
- Improves the downstream clock receiver's (RX) jitter by decreasing (speeding up) the clock rise/fall time.
- Ability to drive large capacitive loads while maintaining full swing with sharp edge rates.

For more detailed information about rise/fall time control and drive strength selection, see the [SiTime Application Notes section](#).

EMI Reduction by Slowing Rise/Fall Time

Figure 16 shows the harmonic power reduction as the rise/fall times are increased (slowed down). The rise/fall times are expressed as a ratio of the clock period. For the ratio of 0.05, the signal is very close to a square wave. For the ratio of 0.45, the rise/fall times are very close to near-triangular waveform. These results, for example, show that the 11th clock harmonic can be reduced by 35 dB if the rise/fall edge is increased from 5% of the period to 45% of the period.

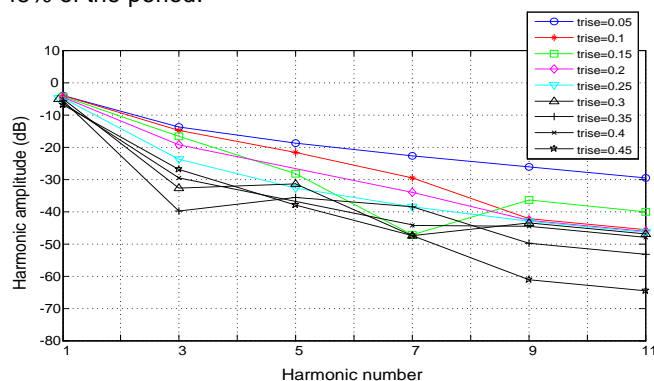


Figure 16. Harmonic EMI reduction as a Function of Slower Rise/Fall Time

Jitter Reduction with Faster Rise/Fall Time

Power supply noise can be a source of jitter for the downstream chipset. One way to reduce this jitter is to speed up the rise/fall time of the input clock. Some chipsets may also require faster rise/fall time in order to reduce their sensitivity to this type of jitter. Refer to the [Rise/Fall Time Tables \(Table 7 to Table 11\)](#) to determine the proper drive strength.

High Output Load Capability

The rise/fall time of the input clock varies as a function of the actual capacitive load the clock drives. At any given drive strength, the rise/fall time becomes slower as the output load increases. As an example, for a 3.3V SiT8944 device with default drive strength setting, the typical rise/fall time is 1 ns for 15 pF output load. The typical rise/fall time slows down to 2.6 ns when the output load increases to 45 pF. One can choose to speed up the rise/fall time to 1.83 ns by then increasing the drive strength setting on the SiT8944.

The SiT8944 can support up to 60 pF in maximum capacitive loads with drive strength settings. Refer to the [Rise/Fall Time Tables \(Table 7 to Table 11\)](#) to determine the proper drive strength for the desired combination of output load vs. rise/fall time.

SiT8944 Drive Strength Selection

Tables 7 through 11 define the rise/fall time for a given capacitive load and supply voltage.

- Select the table that matches the SiT8944 nominal supply voltage (1.8V, 2.5V, 2.8V, 3.0V, 3.3V).
- Select the capacitive load column that matches the application requirement (5 pF to 60 pF)
- Under the capacitive load column, select the desired rise/fall times.
- The left-most column represents the part number code for the corresponding drive strength.
- Add the drive strength code to the part number for ordering purposes.

Calculating Maximum Frequency

Based on the rise and fall time data given in Tables 7 through 11, the maximum frequency the oscillator can operate with guaranteed full swing of the output voltage over temperature can be calculated as follows:

$$\text{Max Frequency} = \frac{1}{5 \times \text{Trf}_{20/80}}$$

where $\text{Trf}_{20/80}$ is the typical value for 20%-80% rise/fall time.

Example 1

Calculate f_{MAX} for the following condition:

- Vdd = 1.8V ([Table 7](#))
- Capacitive Load: 30 pF
- Desired Tr/f time = 3 ns (rise/fall time part number code = E)

Part number for the above example:

SiT8944BME12-18EA66.666660

↑
Drive strength code is inserted here. Default setting is “-”

Rise/Fall Time (20% to 80%) vs C_{LOAD} Tables

Table 7. V_{dd} = 1.8V Rise/Fall Times for Specific C_{LOAD}

Rise/Fall Time Typ (ns)					
Drive Strength \ C _{LOAD}	5 pF	15 pF	30 pF	45 pF	60 pF
L	6.16	11.61	22.00	31.27	39.91
A	3.19	6.35	11.00	16.01	21.52
R	2.11	4.31	7.65	10.77	14.47
B	1.65	3.23	5.79	8.18	11.08
T	0.93	1.91	3.32	4.66	6.48
E	0.78	1.66	2.94	4.09	5.74
U	0.70	1.48	2.64	3.68	5.09
F or "-": default	0.65	1.30	2.40	3.35	4.56

Table 8. V_{dd} = 2.5V Rise/Fall Times for Specific C_{LOAD}

Rise/Fall Time Typ (ns)					
Drive Strength \ C _{LOAD}	5 pF	15 pF	30 pF	45 pF	60 pF
L	4.13	8.25	12.82	21.45	27.79
A	2.11	4.27	7.64	11.20	14.49
R	1.45	2.81	5.16	7.65	9.88
B	1.09	2.20	3.88	5.86	7.57
T	0.62	1.28	2.27	3.51	4.45
E or "-": default	0.54	1.00	2.01	3.10	4.01
U	0.43	0.96	1.81	2.79	3.65
F	0.34	0.88	1.64	2.54	3.32

Table 9. V_{dd} = 2.8V Rise/Fall Times for Specific C_{LOAD}

Rise/Fall Time Typ (ns)					
Drive Strength \ C _{LOAD}	5 pF	15 pF	30 pF	45 pF	60 pF
L	3.77	7.54	12.28	19.57	25.27
A	1.94	3.90	7.03	10.24	13.34
R	1.29	2.57	4.72	7.01	9.06
B	0.97	2.00	3.54	5.43	6.93
T	0.55	1.12	2.08	3.22	4.08
E or "-": default	0.44	1.00	1.83	2.82	3.67
U	0.34	0.88	1.64	2.52	3.30
F	0.29	0.81	1.48	2.29	2.99

Table 10. V_{dd} = 3.0V Rise/Fall Times for Specific C_{LOAD}

Rise/Fall Time Typ (ns)					
Drive Strength \ C _{LOAD}	5 pF	15 pF	30 pF	45 pF	60 pF
L	3.60	7.21	11.97	18.74	24.30
A	1.84	3.71	6.72	9.86	12.68
R	1.22	2.46	4.54	6.76	8.62
B	0.89	1.92	3.39	5.20	6.64
T or "-": default	0.51	1.00	1.97	3.07	3.90
E	0.38	0.92	1.72	2.71	3.51
U	0.30	0.83	1.55	2.40	3.13
F	0.27	0.76	1.39	2.16	2.85

Table 11. V_{dd} = 3.3V Rise/Fall Times for Specific C_{LOAD}

Rise/Fall Time Typ (ns)					
Drive Strength \ C _{LOAD}	5 pF	15 pF	30 pF	45 pF	60 pF
L	3.39	6.88	11.63	17.56	23.59
A	1.74	3.50	6.38	8.98	12.19
R	1.16	2.33	4.29	6.04	8.34
B	0.81	1.82	3.22	4.52	6.33
T or "-": default	0.46	1.00	1.86	2.60	3.84
E	0.33	0.87	1.64	2.30	3.35
U	0.28	0.79	1.46	2.05	2.93
F	0.25	0.72	1.31	1.83	2.61

Pin 1 Configuration Options (OE, \overline{ST} , or NC)

Pin 1 of the SiT8944 can be factory-programmed to support three modes: Output enable (OE), standby \overline{ST} or No Connect (NC). These modes can also be programmed with the Time Machine II using Field Programmable Oscillators.

Output Enable (OE) Mode

In the OE mode, applying logic Low to the OE pin only disables the output driver and puts it in Hi-Z mode. The core of the device continues to operate normally. Power consumption is reduced due to the inactivity of the output. When the OE pin is pulled High, the output is typically enabled in $<1\mu\text{s}$.

Standby (\overline{ST}) Mode

In the \overline{ST} mode, a device enters into the standby mode when Pin 1 pulled Low. All internal circuits of the device are turned off. The current is reduced to a standby current, typically in the range of a few μA . When \overline{ST} is pulled High, the device goes through the “resume” process, which can take up to 5 ms.

No Connect (NC) Mode

In the NC mode, the device always operates in its normal mode and output the specified frequency regardless of the logic level on pin 1.

Table 12 below summarizes the key relevant parameters in the operation of the device in OE, \overline{ST} , or NC mode.

Table 12. OE vs. \overline{ST} vs. NC

	OE	\overline{ST}	NC
Active current 20 MHz (max, 1.8V)	4.5 mA	4.5 mA	4.5 mA
OE disable current (max. 1.8V)	4.3 mA	N/A	N/A
Standby current (typical 1.8V)	N/A	0.6 μA	N/A
OE enable time at 110 MHz (max)	130 ns	N/A	N/A
Resume time from standby (max, all frequency)	N/A	5 ms	N/A
Output driver in OE disable/standby mode	High Z	Weak pull-down	N/A

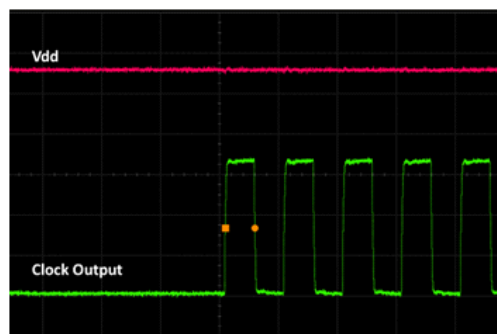
Output on Startup and OE Enable

The SiT8944 comes with gated output. Its clock output is accurate to the rated frequency stability within the first pulse from initial device startup or when the output driver is enabled.

In addition, the SiT8944 supports “no runt” pulses and “no glitch” output during startup or when the device output driver is enabled as shown in the waveform captures in Figure 17 and Figure 18.



Figure 17. Startup Waveform vs. Vdd



**Figure 18. Startup Waveform vs. Vdd
(Zoomed-in View of Figure 17)**

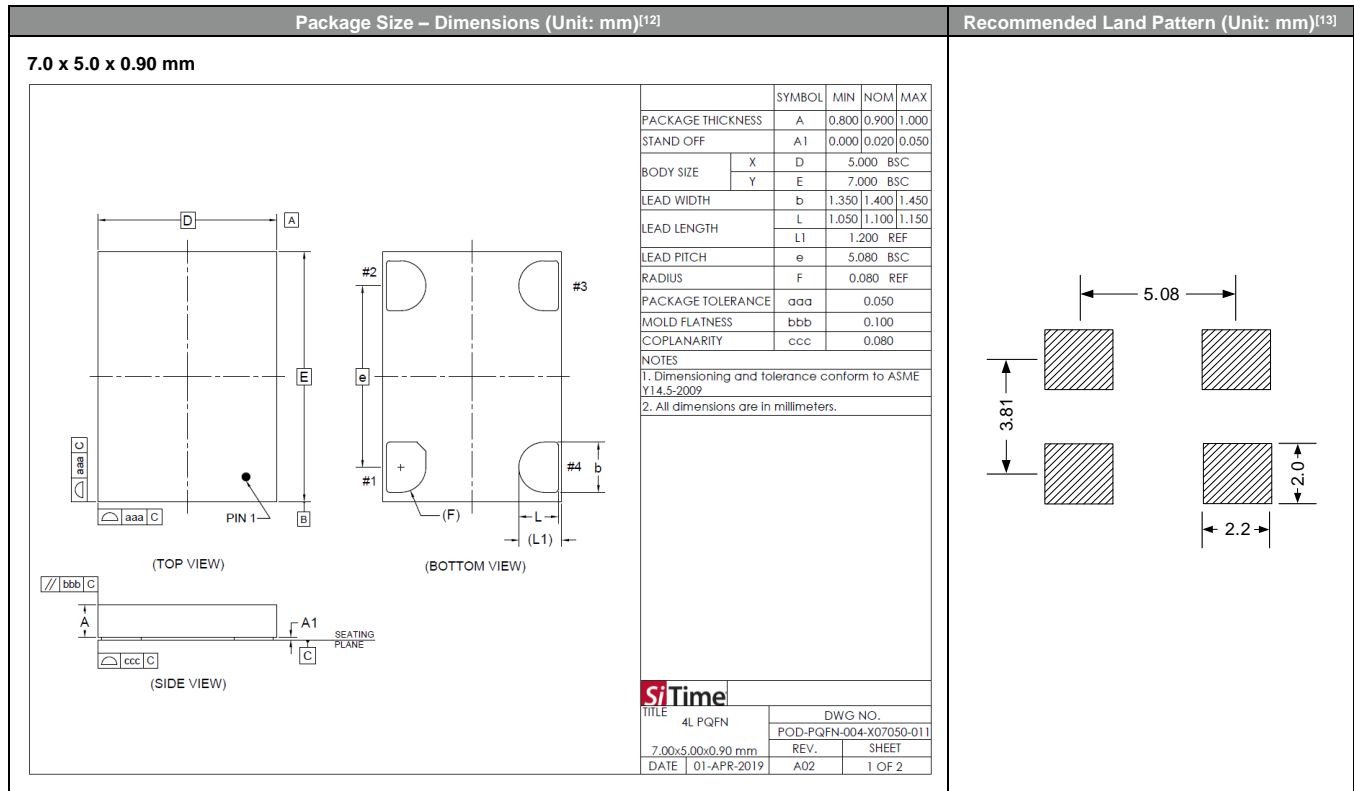
Dimensions and Patterns

Package Size – Dimensions (Unit: mm) ^[12]	Recommended Land Pattern (Unit: mm) ^[13]																																																																																		
<p>2.0 x 1.6 x 0.75 mm</p> <p>(TOP VIEW) (BOTTOM VIEW) (SIDE VIEW)</p> <table border="1" style="width:100%; border-collapse: collapse;"> <thead> <tr> <th>SYMBOL</th> <th>MIN</th> <th>NOM</th> <th>MAX</th> </tr> </thead> <tbody> <tr> <td>PACKAGE THICKNESS</td> <td>A</td> <td>0.700</td> <td>0.750</td> <td>0.800</td> </tr> <tr> <td>STAND OFF</td> <td>A1</td> <td>0.000</td> <td>0.020</td> <td>0.050</td> </tr> <tr> <td rowspan="2">BODY SIZE</td> <td>X</td> <td>D</td> <td colspan="2">1.600 BSC</td> </tr> <tr> <td>Y</td> <td>E</td> <td colspan="2">2.000 BSC</td> </tr> <tr> <td rowspan="2">LEAD WIDTH</td> <td>b</td> <td>0.430</td> <td>0.480</td> <td>0.530</td> </tr> <tr> <td>b1</td> <td>0.230</td> <td>0.280</td> <td>0.330</td> </tr> <tr> <td rowspan="2">LEAD LENGTH</td> <td>L</td> <td>0.580</td> <td>0.680</td> <td>0.780</td> </tr> <tr> <td>L1</td> <td colspan="3">0.100 REF</td> </tr> <tr> <td>LEAD PITCH</td> <td>e</td> <td colspan="3">0.930 BSC</td> </tr> <tr> <td>RADIUS</td> <td>F</td> <td colspan="3">0.100 REF</td> </tr> <tr> <td>PACKAGE TOLERANCE</td> <td>aaa</td> <td colspan="3">0.050</td> </tr> <tr> <td>MOLD FLATNESS</td> <td>bbb</td> <td colspan="3">0.100</td> </tr> <tr> <td>COPLANARITY</td> <td>ccc</td> <td colspan="3">0.080</td> </tr> </tbody> </table> <p>NOTES 1. Dimensioning and tolerance conform to ASME Y14.5-2009 2. All dimensions are in millimeters.</p> <div style="display: flex; justify-content: space-between; align-items: center;"> <table border="1" style="width:100%; border-collapse: collapse;"> <tr> <td>TITLE</td> <td>4L PQFN</td> <td>DWG NO.</td> <td></td> </tr> <tr> <td></td> <td></td> <td>POD-PQFN-004-X01620-026</td> <td></td> </tr> <tr> <td>1.60x2.00x0.75 mm</td> <td>REV.</td> <td>SHEET</td> <td></td> </tr> <tr> <td>DATE</td> <td>01-APR-2019</td> <td>A02</td> <td>1 OF 2</td> </tr> </table> </div>	SYMBOL	MIN	NOM	MAX	PACKAGE THICKNESS	A	0.700	0.750	0.800	STAND OFF	A1	0.000	0.020	0.050	BODY SIZE	X	D	1.600 BSC		Y	E	2.000 BSC		LEAD WIDTH	b	0.430	0.480	0.530	b1	0.230	0.280	0.330	LEAD LENGTH	L	0.580	0.680	0.780	L1	0.100 REF			LEAD PITCH	e	0.930 BSC			RADIUS	F	0.100 REF			PACKAGE TOLERANCE	aaa	0.050			MOLD FLATNESS	bbb	0.100			COPLANARITY	ccc	0.080			TITLE	4L PQFN	DWG NO.				POD-PQFN-004-X01620-026		1.60x2.00x0.75 mm	REV.	SHEET		DATE	01-APR-2019	A02	1 OF 2	
SYMBOL	MIN	NOM	MAX																																																																																
PACKAGE THICKNESS	A	0.700	0.750	0.800																																																																															
STAND OFF	A1	0.000	0.020	0.050																																																																															
BODY SIZE	X	D	1.600 BSC																																																																																
	Y	E	2.000 BSC																																																																																
LEAD WIDTH	b	0.430	0.480	0.530																																																																															
	b1	0.230	0.280	0.330																																																																															
LEAD LENGTH	L	0.580	0.680	0.780																																																																															
	L1	0.100 REF																																																																																	
LEAD PITCH	e	0.930 BSC																																																																																	
RADIUS	F	0.100 REF																																																																																	
PACKAGE TOLERANCE	aaa	0.050																																																																																	
MOLD FLATNESS	bbb	0.100																																																																																	
COPLANARITY	ccc	0.080																																																																																	
TITLE	4L PQFN	DWG NO.																																																																																	
		POD-PQFN-004-X01620-026																																																																																	
1.60x2.00x0.75 mm	REV.	SHEET																																																																																	
DATE	01-APR-2019	A02	1 OF 2																																																																																
<p>2.5 x 2.0 x 0.75 mm</p> <p>(TOP VIEW) (BOTTOM VIEW) (SIDE VIEW)</p> <table border="1" style="width:100%; border-collapse: collapse;"> <thead> <tr> <th>SYMBOL</th> <th>MIN</th> <th>NOM</th> <th>MAX</th> </tr> </thead> <tbody> <tr> <td>PACKAGE THICKNESS</td> <td>A</td> <td>0.700</td> <td>0.750</td> <td>0.800</td> </tr> <tr> <td>THICKNESS</td> <td>A1</td> <td>0.000</td> <td>0.020</td> <td>0.050</td> </tr> <tr> <td rowspan="2">BODY SIZE</td> <td>X</td> <td>D</td> <td colspan="2">2.000 BSC</td> </tr> <tr> <td>Y</td> <td>E</td> <td colspan="2">2.500 BSC</td> </tr> <tr> <td>LEAD WIDTH</td> <td>b</td> <td>0.300</td> <td>0.350</td> <td>0.400</td> </tr> <tr> <td>LEAD LENGTH</td> <td>L</td> <td>0.650</td> <td>0.750</td> <td>0.850</td> </tr> <tr> <td>LEAD PITCH</td> <td>e</td> <td colspan="3">1.250 BSC</td> </tr> <tr> <td>PACKAGE TOLERANCE</td> <td>aaa</td> <td colspan="3">0.050</td> </tr> <tr> <td>MOLD FLATNESS</td> <td>bbb</td> <td colspan="3">0.100</td> </tr> <tr> <td>COPLANARITY</td> <td>ccc</td> <td colspan="3">0.080</td> </tr> </tbody> </table> <p>NOTES 1. Dimensioning and tolerance conform to ASME Y14.5-2009 2. All dimensions are in millimeters.</p> <div style="display: flex; justify-content: space-between; align-items: center;"> <table border="1" style="width:100%; border-collapse: collapse;"> <tr> <td>TITLE</td> <td>4L PQFN</td> <td>DWG NO.</td> <td></td> </tr> <tr> <td></td> <td></td> <td>POD-PQFN-004-X02025-010</td> <td></td> </tr> <tr> <td>2.00x2.50x0.75 mm</td> <td>REV.</td> <td>SHEET</td> <td></td> </tr> <tr> <td>DATE</td> <td>01-APR-2019</td> <td>A02</td> <td>1 OF 2</td> </tr> </table> </div>	SYMBOL	MIN	NOM	MAX	PACKAGE THICKNESS	A	0.700	0.750	0.800	THICKNESS	A1	0.000	0.020	0.050	BODY SIZE	X	D	2.000 BSC		Y	E	2.500 BSC		LEAD WIDTH	b	0.300	0.350	0.400	LEAD LENGTH	L	0.650	0.750	0.850	LEAD PITCH	e	1.250 BSC			PACKAGE TOLERANCE	aaa	0.050			MOLD FLATNESS	bbb	0.100			COPLANARITY	ccc	0.080			TITLE	4L PQFN	DWG NO.				POD-PQFN-004-X02025-010		2.00x2.50x0.75 mm	REV.	SHEET		DATE	01-APR-2019	A02	1 OF 2														
SYMBOL	MIN	NOM	MAX																																																																																
PACKAGE THICKNESS	A	0.700	0.750	0.800																																																																															
THICKNESS	A1	0.000	0.020	0.050																																																																															
BODY SIZE	X	D	2.000 BSC																																																																																
	Y	E	2.500 BSC																																																																																
LEAD WIDTH	b	0.300	0.350	0.400																																																																															
LEAD LENGTH	L	0.650	0.750	0.850																																																																															
LEAD PITCH	e	1.250 BSC																																																																																	
PACKAGE TOLERANCE	aaa	0.050																																																																																	
MOLD FLATNESS	bbb	0.100																																																																																	
COPLANARITY	ccc	0.080																																																																																	
TITLE	4L PQFN	DWG NO.																																																																																	
		POD-PQFN-004-X02025-010																																																																																	
2.00x2.50x0.75 mm	REV.	SHEET																																																																																	
DATE	01-APR-2019	A02	1 OF 2																																																																																

Dimensions and Patterns (continued)

Package Size – Dimensions (Unit: mm) ^[12]	Recommended Land Pattern (Unit: mm) ^[13]																																																											
<p>3.2 x 2.5 x 0.75 mm</p> <p>(TOP VIEW) (BOTTOM VIEW) (SIDE VIEW)</p> <table border="1"> <thead> <tr> <th></th> <th>SYMBOL</th> <th>MIN</th> <th>NOM</th> <th>MAX</th> </tr> </thead> <tbody> <tr> <td>PACKAGE THICKNESS</td> <td>A</td> <td>0.700</td> <td>0.750</td> <td>0.800</td> </tr> <tr> <td>STAND OFF</td> <td>A1</td> <td>0.000</td> <td>0.020</td> <td>0.050</td> </tr> <tr> <td rowspan="2">BODY SIZE</td> <td>X</td> <td>D</td> <td>2.500</td> <td>BSC</td> </tr> <tr> <td>Y</td> <td>E</td> <td>3.200</td> <td>BSC</td> </tr> <tr> <td>LEAD WIDTH</td> <td>b</td> <td>0.800</td> <td>0.900</td> <td>1.000</td> </tr> <tr> <td>LEAD LENGTH</td> <td>L</td> <td>0.700</td> <td>0.800</td> <td>0.900</td> </tr> <tr> <td>LEAD PITCH</td> <td>L1</td> <td>0.100</td> <td>REF</td> <td></td> </tr> <tr> <td>RADIUS</td> <td>F</td> <td>0.450</td> <td>REF</td> <td></td> </tr> <tr> <td>PACKGE TOLERANCE</td> <td>aaa</td> <td>0.050</td> <td></td> <td></td> </tr> <tr> <td>MOLD FLATNESS</td> <td>bbb</td> <td>0.100</td> <td></td> <td></td> </tr> <tr> <td>COPLANARITY</td> <td>ccc</td> <td>0.080</td> <td></td> <td></td> </tr> </tbody> </table> <p>NOTES 1. Dimensioning and tolerance conform to ASME Y14.5-2009 2. All dimensions are in millimeters.</p> <p>SiTime TITLE: 4L PQFN DWG NO.: POD-PQFN-004-X03225-002 3.20x2.50x0.75 mm REV.: SHEET DATE: 01-APR-2019 A04 1 OF 2</p>		SYMBOL	MIN	NOM	MAX	PACKAGE THICKNESS	A	0.700	0.750	0.800	STAND OFF	A1	0.000	0.020	0.050	BODY SIZE	X	D	2.500	BSC	Y	E	3.200	BSC	LEAD WIDTH	b	0.800	0.900	1.000	LEAD LENGTH	L	0.700	0.800	0.900	LEAD PITCH	L1	0.100	REF		RADIUS	F	0.450	REF		PACKGE TOLERANCE	aaa	0.050			MOLD FLATNESS	bbb	0.100			COPLANARITY	ccc	0.080			
	SYMBOL	MIN	NOM	MAX																																																								
PACKAGE THICKNESS	A	0.700	0.750	0.800																																																								
STAND OFF	A1	0.000	0.020	0.050																																																								
BODY SIZE	X	D	2.500	BSC																																																								
	Y	E	3.200	BSC																																																								
LEAD WIDTH	b	0.800	0.900	1.000																																																								
LEAD LENGTH	L	0.700	0.800	0.900																																																								
LEAD PITCH	L1	0.100	REF																																																									
RADIUS	F	0.450	REF																																																									
PACKGE TOLERANCE	aaa	0.050																																																										
MOLD FLATNESS	bbb	0.100																																																										
COPLANARITY	ccc	0.080																																																										
<p>5.0 x 3.2 x 0.75 mm</p> <p>(TOP VIEW) (BOTTOM VIEW) (SIDE VIEW)</p> <table border="1"> <thead> <tr> <th></th> <th>SYMBOL</th> <th>MIN</th> <th>NOM</th> <th>MAX</th> </tr> </thead> <tbody> <tr> <td>PACKAGE THICKNESS</td> <td>A</td> <td>0.700</td> <td>0.750</td> <td>0.800</td> </tr> <tr> <td>STAND OFF</td> <td>A1</td> <td>0.000</td> <td>0.020</td> <td>0.050</td> </tr> <tr> <td rowspan="2">BODY SIZE</td> <td>X</td> <td>D</td> <td>3.200</td> <td>BSC</td> </tr> <tr> <td>Y</td> <td>E</td> <td>5.000</td> <td>BSC</td> </tr> <tr> <td>LEAD WIDTH</td> <td>b</td> <td>1.000</td> <td>1.100</td> <td>1.200</td> </tr> <tr> <td>LEAD LENGTH</td> <td>L</td> <td>1.050</td> <td>1.100</td> <td>1.150</td> </tr> <tr> <td>LEAD PITCH</td> <td>L1</td> <td>1.200</td> <td>REF</td> <td></td> </tr> <tr> <td>RADIUS</td> <td>F</td> <td>0.575</td> <td></td> <td></td> </tr> <tr> <td>PACKGE TOLERANCE</td> <td>aaa</td> <td>0.050</td> <td></td> <td></td> </tr> <tr> <td>MOLD FLATNESS</td> <td>bbb</td> <td>0.100</td> <td></td> <td></td> </tr> <tr> <td>COPLANARITY</td> <td>ccc</td> <td>0.080</td> <td></td> <td></td> </tr> </tbody> </table> <p>NOTES 1. Dimensioning and tolerance conform to ASME Y14.5-2009 2. All dimensions are in millimeters.</p> <p>SiTime TITLE: 4L PQFN DWG NO.: POD-PQFN-004-X05032-003 5.00x3.20x0.75 mm REV.: SHEET DATE: 01-APR-2019 A04 1 OF 2</p>		SYMBOL	MIN	NOM	MAX	PACKAGE THICKNESS	A	0.700	0.750	0.800	STAND OFF	A1	0.000	0.020	0.050	BODY SIZE	X	D	3.200	BSC	Y	E	5.000	BSC	LEAD WIDTH	b	1.000	1.100	1.200	LEAD LENGTH	L	1.050	1.100	1.150	LEAD PITCH	L1	1.200	REF		RADIUS	F	0.575			PACKGE TOLERANCE	aaa	0.050			MOLD FLATNESS	bbb	0.100			COPLANARITY	ccc	0.080			
	SYMBOL	MIN	NOM	MAX																																																								
PACKAGE THICKNESS	A	0.700	0.750	0.800																																																								
STAND OFF	A1	0.000	0.020	0.050																																																								
BODY SIZE	X	D	3.200	BSC																																																								
	Y	E	5.000	BSC																																																								
LEAD WIDTH	b	1.000	1.100	1.200																																																								
LEAD LENGTH	L	1.050	1.100	1.150																																																								
LEAD PITCH	L1	1.200	REF																																																									
RADIUS	F	0.575																																																										
PACKGE TOLERANCE	aaa	0.050																																																										
MOLD FLATNESS	bbb	0.100																																																										
COPLANARITY	ccc	0.080																																																										

Dimensions and Patterns (continued)



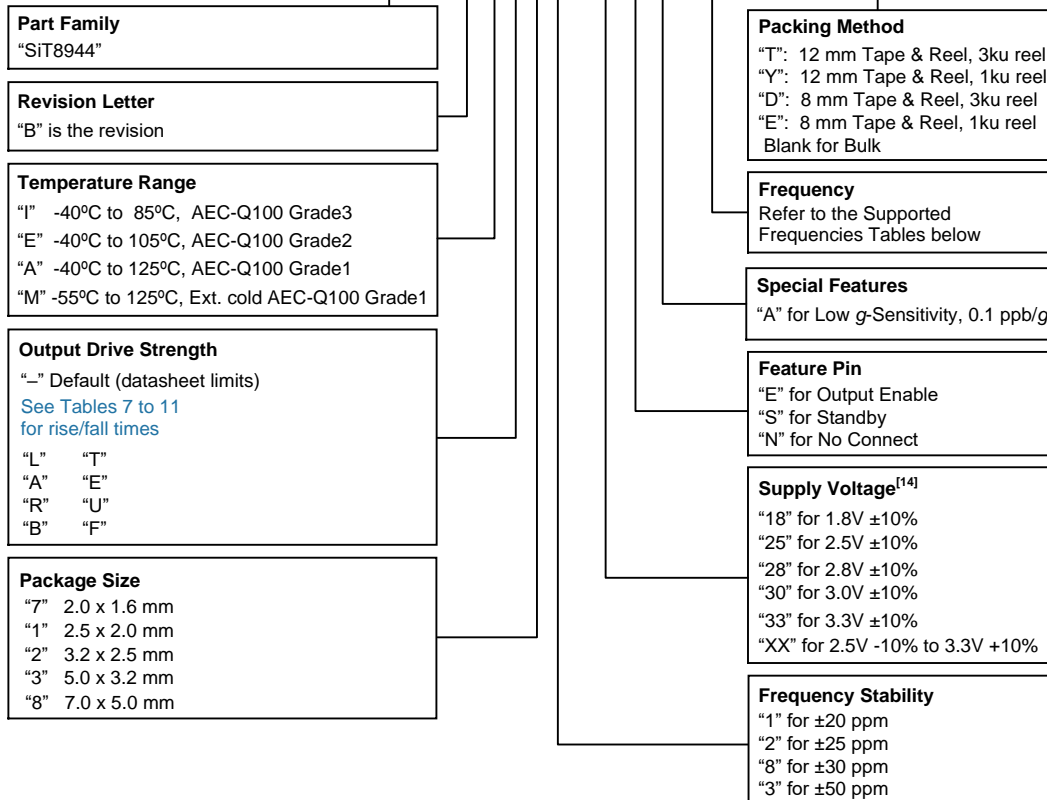
Notes:

12. Top marking: Y denotes manufacturing origin and XXXX denotes manufacturing lot number. The value of “Y” will depend on the assembly location of the device.
13. A capacitor of value 0.1 μF or higher between Vdd and GND is required.

Ordering Information

The following part number guide is for reference only. To customize and build an exact part number, use the SiTime [Part Number Generator](#).

SiT8944BA-12-18EA 66.666666D



Note:

- The voltage portion of the SiT8944 part number consists of two characters that denote the specific supply voltage of the device. The SiT8944 supports either 1.8V ±10% or any voltage between 2.25V and 3.62V. In the 1.8V mode, one can simply insert 18 in the part number. In the 2.5V to 3.3V mode, two digits such as 18, 25 or 33 can be used in the part number to reflect the desired voltage. Alternatively, "XX" can be used to indicate the entire operating voltage range from 2.25V to 3.63V.

Table 13. Supported Frequencies
 (-40°C to +85°C)^[15]

Frequency Range	
Min.	Max.
1.000000 MHz	110.000000 MHz

Table 14. Supported Frequencies
 (-40°C to +105°C or -40°C to +125°C)^[15, 16]

Frequency Range	
Min.	Max.
1.000000 MHz	61.222999 MHz
61.974001 MHz	69.795999 MHz
70.485001 MHz	79.062999 MHz
79.162001 MHz	81.427999 MHz
82.232001 MHz	91.833999 MHz
92.155001 MHz	94.248999 MHz
94.430001 MHz	94.874999 MHz
94.994001 MHz	97.713999 MHz
98.679001 MHz	110.000000 MHz

Table 15. Supported Frequencies
 (-55°C to +125°C)^[15, 16]

Frequency Range	
Min.	Max.
1.000000 MHz	61.222999 MHz
61.974001 MHz	69.239999 MHz
70.827001 MHz	78.714999 MHz
79.561001 MHz	80.159999 MHz
80.174001 MHz	80.779999 MHz
82.632001 MHz	91.833999 MHz
95.474001 MHz	96.191999 MHz
96.209001 MHz	96.935999 MHz
99.158001 MHz	110.000000 MHz

Notes:

15. Any frequency within the min and max values in the above tables are supported with 6 decimal places of accuracy.
 16. Please [contact SiTime](#) for frequencies that are not listed in the tables above.

Table 16. Ordering Codes for Supported Tape & Reel Packing Method

Device Size (mm x mm)	16 mm T&R (3ku)	16 mm T&R (1ku)	12 mm T&R (3ku)	12 mm T&R (1ku)	8 mm T&R (3ku)	8 mm T&R (1ku)
2.0 x 1.6	–	–	–	–	D	E
2.5 x 2.0	–	–	–	–	D	E
3.2 x 2.5	–	–	–	–	D	E
5.0 x 3.2	–	–	T	Y	–	–
7.0 x 5.0	T	Y	–	–	–	–

Table 17. Revision History

Revision	Release Date	Change Summary
0.5	07/22/2019	First release
1.00	07/24/2020	Final release

SiTime Corporation, 5451 Patrick Henry Drive, Santa Clara, CA 95054, USA | **Phone:** +1-408-328-4400 | **Fax:** +1-408-328-4439

© SiTime Corporation 2020. The information contained herein is subject to change at any time without notice. SiTime assumes no responsibility or liability for any loss, damage or defect of a Product which is caused in whole or in part by (i) use of any circuitry other than circuitry embodied in a SiTime product, (ii) misuse or abuse including static discharge, neglect or accident, (iii) unauthorized modification or repairs which have been soldered or altered during assembly and are not capable of being tested by SiTime under its normal test conditions, or (iv) improper installation, storage, handling, warehousing or transportation, or (v) being subjected to unusual physical, thermal, or electrical stress.

Disclaimer: SiTime makes no warranty of any kind, express or implied, with regard to this material, and specifically disclaims any and all express or implied warranties, either in fact or by operation of law, statutory or otherwise, including the implied warranties of merchantability and fitness for use or a particular purpose, and any implied warranty arising from course of dealing or usage of trade, as well as any common-law duties relating to accuracy or lack of negligence, with respect to this material, any SiTime product and any product documentation. Products sold by SiTime are not suitable or intended to be used in a life support application or component, to operate nuclear facilities, or in other mission critical applications where human life may be involved or at stake. All sales are made conditioned upon compliance with the critical uses policy set forth below.

CRITICAL USE EXCLUSION POLICY

BUYER AGREES NOT TO USE SITIME'S PRODUCTS FOR ANY APPLICATION OR IN ANY COMPONENTS USED IN LIFE SUPPORT DEVICES OR TO OPERATE NUCLEAR FACILITIES OR FOR USE IN OTHER MISSION-CRITICAL APPLICATIONS OR COMPONENTS WHERE HUMAN LIFE OR PROPERTY MAY BE AT STAKE.

SiTime owns all rights, title and interest to the intellectual property related to SiTime's products, including any software, firmware, copyright, patent, or trademark. The sale of SiTime products does not convey or imply any license under patent or other rights. SiTime retains the copyright and trademark rights in all documents, catalogs and plans supplied pursuant to or ancillary to the sale of products or services by SiTime. Unless otherwise agreed to in writing by SiTime, any reproduction, modification, translation, compilation, or representation of this material shall be strictly prohibited.